



30V Complementary Enhancement Mode MOSFET

Voltage

30/-30 V

Current

25/-22 A

Features

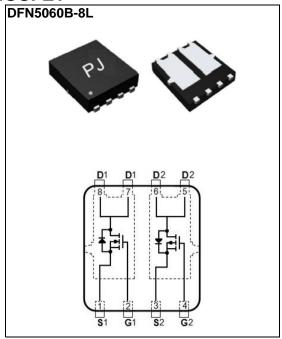
- High switching speed
- Improved dv/dt capability
- Low Gate Charge
- Low reverse transfer capacitance
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: DFN5060B-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0035 ounces, 0.092 grams



Maximum Ratings and Thermal Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER		SYMBOL	N-CH LIMIT	P-CH LIMIT	UNITS	
Drain-Source Voltage		V_{DS}	30	-30	V	
Gate-Source Voltage		V_{GS}	<u>+</u> 20		V	
Continuous Drain Current (Note 4)	T _C =25°C		25	-22	A	
	T _C =100°C	l _D	16	-14		
Pulsed Drain Current (Note 1)	T _C =25°C	I _{DM}	100	-88		
Power Dissipation	T _C =25°C	ı	21		W	
	T _C =100°C	Pb	8.4			
Continuous Drain Current (Note 4)	T _A =25°C	I _D	7	-6.1	A	
	T _A =70°C		5.6	-5		
Power Dissipation	T _A =25°C	ſ	1.7		W	
	T _A =70°C	Pb	1.			
Operating Junction and Storage Temperature Range		T_J, T_{STG}	-55~150		°C	
Typical Thermal Resistance (Note 4,5)	Junction to Case	$R_{ heta JC}$	6 73.5		°C/W	
	Junction to Ambient	$R_{\theta JA}$				

Limited only By Maximum Junction Temperature





N-CH Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static	OTHIBOL	1201 GONDITION	101114		III/-QX:	Olulo	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	30	-	-	.,	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250uA$	1	1.67	2.5	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =8A	-	16	19	mΩ	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =5A	-	22	28		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V	-	-	1	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 20V, V _{DS} =0V	-	-	<u>+</u> 100	nA	
Dynamic (Note 6)							
Total Gate Charge	Qg	V _{DS} =15V, I _D =8A, V _{GS} =4.5V ^(Note 2,3)	-	4.8	-	nC	
Gate-Source Charge	Q _{gs}		-	1.5	-		
Gate-Drain Charge	Q_{gd}		-	2	-		
Input Capacitance	Ciss	V _{DS} =25V, V _{GS} =0V, f=1MHZ	-	429	-		
Output Capacitance	Coss		-	59	-	pF	
Reverse Transfer Capacitance	Crss		-	47	-		
Turn-On Delay Time	td _(on)	V _{DS} =15V, I _D =1A,	-	6.8	-		
Turn-On Rise Time	t _r	V_{GS} =10V, R_{G} =6 Ω (Note 2,3)	-	16	-		
Turn-Off Delay Time	td _(off)		-	27	-	ns	
Turn-Off Fall Time	t _f		-	7.1	-		
Drain-Source Diode							
Maximum Continuous Drain-Source					0.5		
Diode Forward Current	I _S			-	-	25	Α
Diode Forward Voltage	V_{SD}	I _S =1A, V _{GS} =0V	-	0.74	1	V	





P-CH Electrical Characteristics (T_A=25 °C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static		120100112111011				
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA	-30	-	-	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250uA	-1	-1.53	-2.5	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-4A	-	25	30	0
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-2A	-	36	45	mΩ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V	-	-	-1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} = <u>+</u> 20V, V _{DS} =0V	-	-	<u>+</u> 100	nA
Dynamic (Note 6)						
Total Gate Charge	Qg	451/ 1 44	-	7.8	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-15V, I_{D} =-4A, V_{GS} =-4.5V (Note 1,2)	-	2.7	-	
Gate-Drain Charge	Q_{gd}		-	2.8	-	
Input Capacitance	Ciss	V _{DS} =-15V, V _{GS} =0V, f=1MHZ	-	846	-	
Output Capacitance	Coss		-	120	-	pF
Reverse Transfer Capacitance	Crss		-	76	-	
Turn-On Delay Time	td _(on)		-	3.6	-	
Turn-On Rise Time	t _r	V_{DS} =-15V, I_{D} =-1A, V_{GS} =-10V, R_{G} =6 Ω (Note 1,2)	-	23	-	
Turn-Off Delay Time	td _(off)		-	90	-	ns
Turn-Off Fall Time	t _f		-	50	-	
Drain-Source Diode						
Maximum Continuous Drain-Source				-	-22	А
Diode Forward Current	I _S		-			
Diode Forward Voltage	V_{SD}	I _S =-1A, V _{GS} =0V	-	-0.75	-1	V

NOTES:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150°C. Ratings are based on low frequency and duty cycles to keep initial T_J =25°C.
- 4. The maximum current rating is package limited.
- 5. R_{OJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper..
- 6. Guaranteed by design, not subject to production testing.





N-CH TYPICAL CHARACTERISTIC CURVES

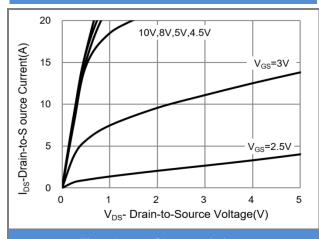


Fig.1 Output Characteristics

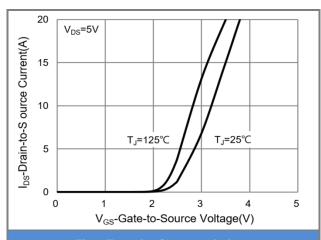


Fig.2 Transfer Characteristics

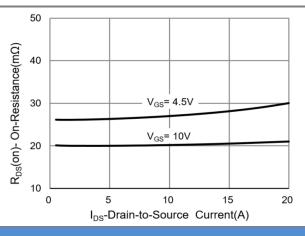


Fig.3 On-Resistance vs. Drain Current

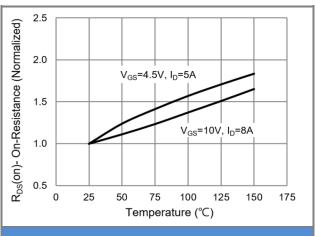
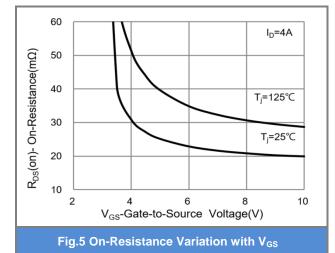


Fig.4 On-Resistance vs. Junction temperature



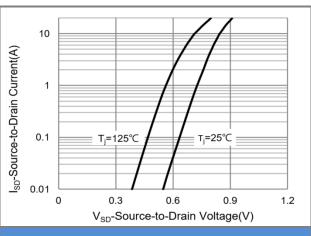


Fig.6 Source-Drain Diode Forward Voltage





TYPICAL CHARACTERISTIC CURVES

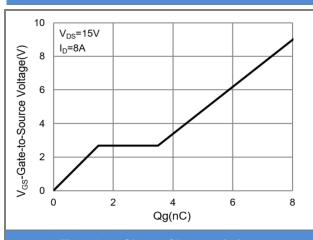


Fig.7 Gate-Charge Characteristics

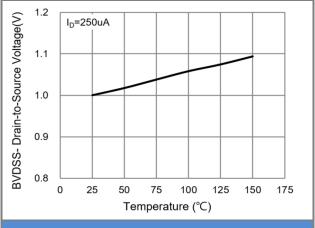


Fig.8 Breakdown Voltage Variation vs. Temperature

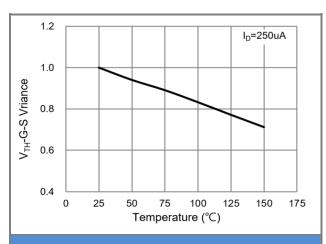


Fig.9 Threshold Voltage Variation with Temperature

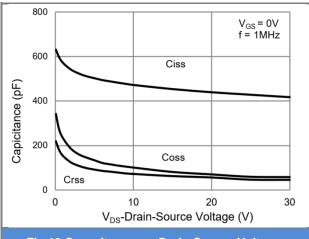


Fig.10 Capacitance vs. Drain-Source Voltage

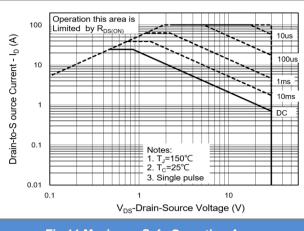


Fig.11 Maximum Safe Operating Area

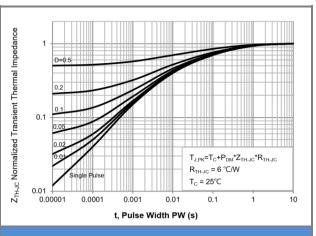


Fig.12 Normalized Transient Thermal Impedance





P-CH TYPICAL CHARACTERISTIC CURVES

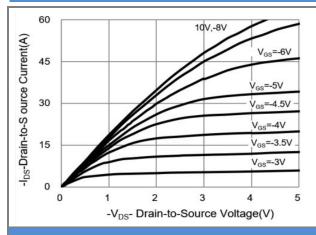


Fig.13 Output Characteristics

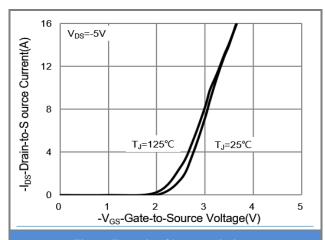


Fig.14 Transfer Characteristics

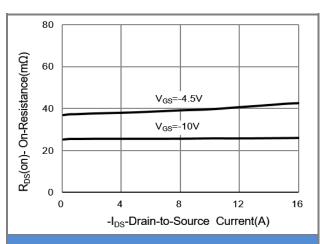


Fig.15 On-Resistance vs. Drain Current

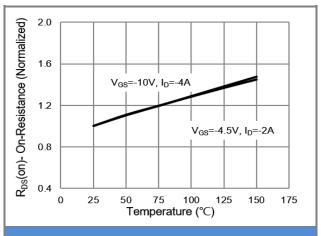
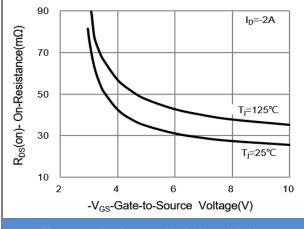


Fig.16 On-Resistance vs. Junction temperature





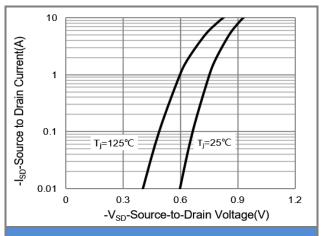


Fig.18 Source-Drain Diode Forward Voltage





TYPICAL CHARACTERISTIC CURVES

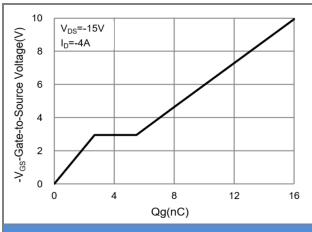


Fig.19 Gate-Charge Characteristics

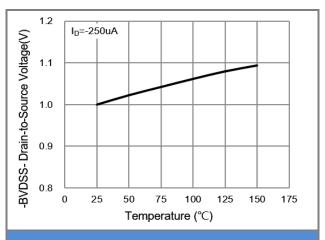


Fig.20 Breakdown Voltage Variation vs. Temperature

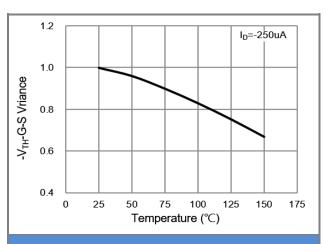


Fig.21 Threshold Voltage Variation with Temperature

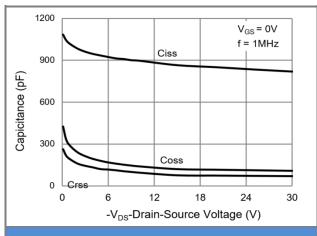


Fig.22 Capacitance vs. Drain-Source Voltage

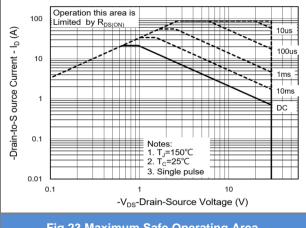


Fig.23 Maximum Safe Operating Area

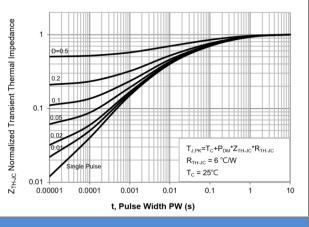


Fig.24 Normalized Transient Thermal Impedance

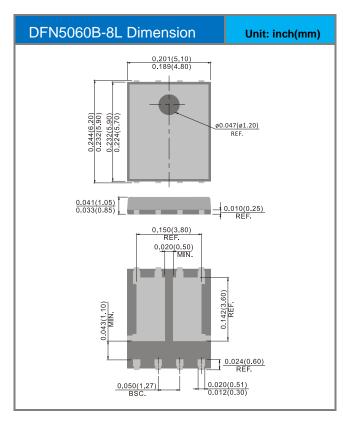


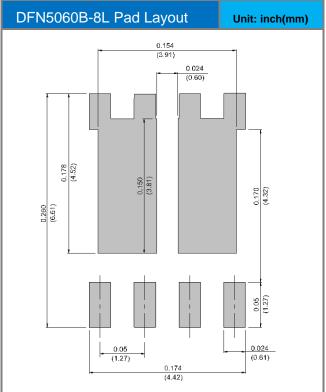


Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version	
PJQ5606_R2_00001	DFN5060B-8L	3000pcs / 13" reel	Q5606	Halogen free	

Packaging Information & Mounting Pad Layout









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